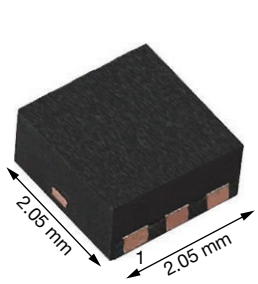
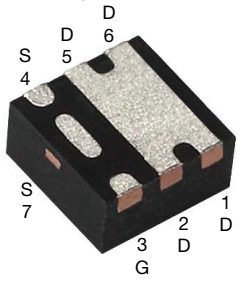
# Automotive N-Channel 30 V (D-S) 175 °C MOSFET

**PowerPAK® SC-70-6L Single**




Top View




Bottom View

**Marking Code**: QHXXXX

## FEATURES

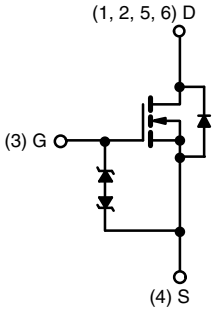
- TrenchFET® power MOSFET
- AEC-Q101 qualified
- 100 % $R_g$ and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

AUTOMOTIVE GRADE

Pb-free

RoHS COMPLIANT

HALOGEN FREE




N-Channel MOSFET

| PRODUCT SUMMARY | |
|---|---|
| $V_{DS}$ (V) | 30 |
| $R_{DS(on)}$ (Ω) at $V_{GS}$ = 4.5 V | 0.056 |
| $R_{DS(on)}$ (Ω) at $V_{GS}$ = 2.5 V | 0.070 |
| $I_D$ (A) | 2.25 |
| Configuration | Single |
| Package | PowerPAK SC-70 |

**ABSOLUTE MAXIMUM RATINGS** ($T_C$ = 25 °C, unless otherwise noted)

| PARAMETER | | SYMBOL | LIMIT | UNIT |
|---|---|---|---|---|
| Drain-source voltage | | $V_{DS}$ | 30 | V |
| Gate-source voltage | | $V_{GS}$ | ± 12 | |
| Continuous drain current [a] | $T_C$ = 25 °C | $I_D$ | 2.25 | A |
| | $T_C$ = 125 °C | | 2.25 | |
| Continuous source current (diode conduction) [a] | | $I_S$ | 2.25 | |
| Pulsed drain current [a] | | $I_{DM}$ | 9 | |
| Single pulse avalanche current | L = 0.1 mH | $I_{AS}$ | 9 | |
| Single pulse avalanche energy | | $E_{AS}$ | 4 | mJ |
| Maximum power dissipation [b] | $T_C$ = 25 °C | $P_D$ | 13.6 | W |
| | $T_C$ = 125 °C | | 4.5 | |
| Operating junction and storage temperature range | | $T_J$, $T_{stg}$ | -55 to +175 | °C |
| Soldering recommendations (peak temperature) [d, e] | | | 260 | |

**THERMAL RESISTANCE RATINGS**

| PARAMETER | | SYMBOL | LIMIT | UNIT |
|---|---|---|---|---|
| Junction-to-ambient | PCB mount [c] | $R_{thJA}$ | 90 | °C/W |
| Junction-to-case (drain) | | $R_{thJC}$ | 11 | |

**Notes**

a. Package limited
b. Pulse test; pulse width ≤ 300 µs, duty cycle ≤ 2 %
c. When mounted on 1" square PCB (FR4 material)
d. See solder profile (www.vishay.com/doc?73257). The PowerPAK SC-70 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components

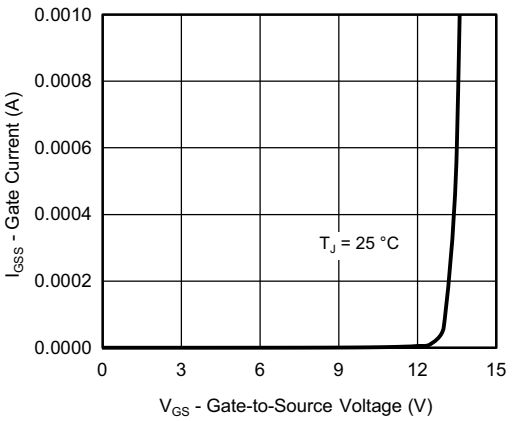
| **SPECIFICATIONS** ($T_C$ = 25 °C, unless otherwise noted) | | | | | | | |
|---|---|---|---|---|---|---|---|
| **PARAMETER** | **SYMBOL** | **TEST CONDITIONS** | | **MIN.** | **TYP.** | **MAX.** | **UNIT** |
| **Static** | | | | | | | |
| Drain-source breakdown voltage | $V_{DS}$ | $V_{GS}$ = 0 V, $I_D$ = 250 µA | | 30 | - | - | V |
| Gate-source threshold voltage | $V_{GS(th)}$ | $V_{DS}$ = $V_{GS}$, $I_D$ = 250 µA | | 0.6 | 1 | 1.6 | |
| Gate-source leakage | $I_{GSS}$ | $V_{DS}$ = 0 V, $V_{GS}$ = ± 3 V | | - | - | ± 100 | nA |
| | | $V_{DS}$ = 0 V, $V_{GS}$ = ± 12 V | | - | - | ± 15 | µA |
| Zero gate voltage drain current | $I_{DSS}$ | $V_{GS}$ = 0 V | $V_{DS}$ = 30 V | - | - | 1 | |
| | | $V_{GS}$ = 0 V | $V_{DS}$ = 30 V, $T_J$ = 125 °C | - | - | 50 | |
| | | $V_{GS}$ = 0 V | $V_{DS}$ = 30 V, $T_J$ = 175 °C | - | - | 250 | |
| On-state drain current [a] | $I_{D(on)}$ | $V_{GS}$ = 4.5 V | $V_{DS}$ ≥ 5 V | 10 | - | - | A |
| Drain-source on-state resistance [a] | $R_{DS(on)}$ | $V_{GS}$ = 4.5 V | $I_D$ = 2 A | - | 0.038 | 0.056 | Ω |
| | | $V_{GS}$ = 4.5 V | $I_D$ = 2 A, $T_J$ = 125 °C | - | - | 0.084 | |
| | | $V_{GS}$ = 4.5 V | $I_D$ = 2 A, $T_J$ = 175 °C | - | - | 0.099 | |
| | | $V_{GS}$ = 2.5 V | $I_D$ = 2 A | - | 0.044 | 0.070 | |
| Forward transconductance [b] | $g_{fs}$ | $V_{DS}$ = 15 V, $I_D$ = 3 A | | - | 13 | - | S |
| **Dynamic [b]** | | | | | | | |
| Input capacitance | $C_{iss}$ | $V_{GS}$ = 0 V | $V_{DS}$ = 20 V, f = 1 MHz | - | 362 | 453 | pF |
| Output capacitance | $C_{oss}$ | | | - | 66 | 83 | |
| Reverse transfer capacitance | $C_{rss}$ | | | - | 38 | 48 | |
| Total gate charge [c] | $Q_g$ | $V_{GS}$ = 4.5 V | $V_{DS}$ = 15 V, $I_D$ = 4.2 A | - | 4.1 | 5.2 | nC |
| Gate-source charge [c] | $Q_{gs}$ | | | - | 0.58 | - | |
| Gate-drain charge [c] | $Q_{gd}$ | | | - | 1.1 | - | |
| Gate resistance | $R_g$ | f = 1 MHz | | 1.9 | 3.2 | 5.1 | Ω |
| Turn-on delay time [c] | $t_{d(on)}$ | $V_{DD}$ = 10 V, $R_L$ = 10 Ω<br>$I_D$ ≅ 1 A, $V_{GEN}$ = 4.5 V, $R_g$ = 1 Ω | | - | 8.2 | 10.3 | ns |
| Rise time[c] | $t_r$ | | | - | 22 | 28 | |
| Turn-off delay time [c] | $t_{d(off)}$ | | | - | 21 | 26 | |
| Fall time [c] | $t_f$ | | | - | 26 | 32 | |
| **Source-Drain Diode Ratings and Characteristics [b]** | | | | | | | |
| Pulsed current [a] | $I_{SM}$ | | | - | - | 9 | A |
| Forward voltage | $V_{SD}$ | $I_F$ = 4.5 A, $V_{GS}$ = 0 V | | - | 0.75 | 1.2 | V |

**Notes**

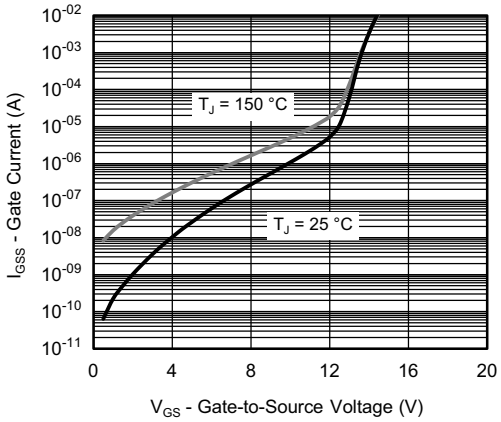
a. Pulse test; pulse width ≤ 300 µs, duty cycle ≤ 2 %
b. Guaranteed by design, not subject to production testing
c. Independent of operating temperature

*Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.*

**TYPICAL CHARACTERISTICS** ($T_A$ = 25 °C, unless otherwise noted)




**Gate Current vs. Gate-Source Voltage**

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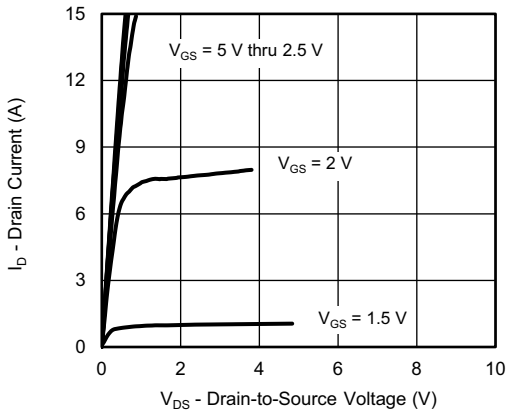
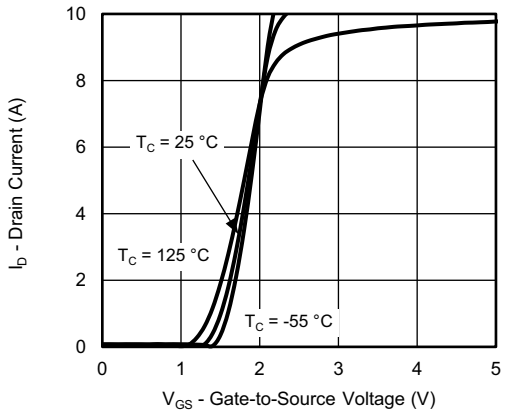
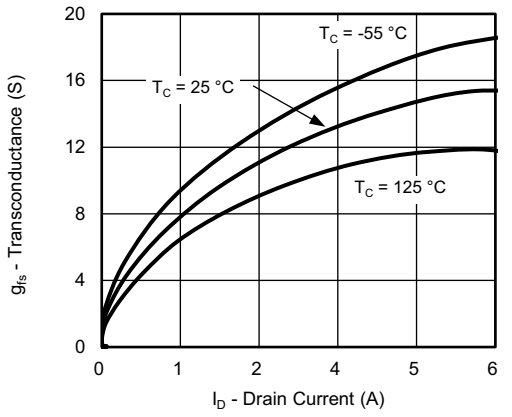


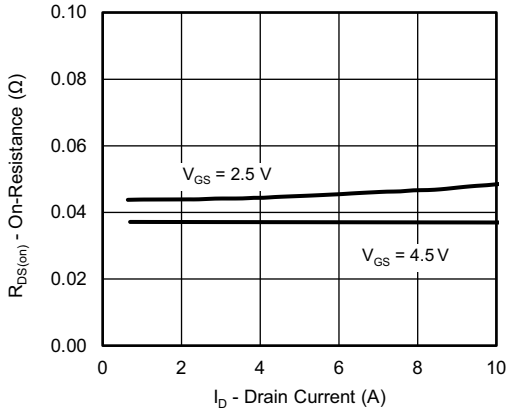

**Output Characteristics**




**Transfer Characteristics**

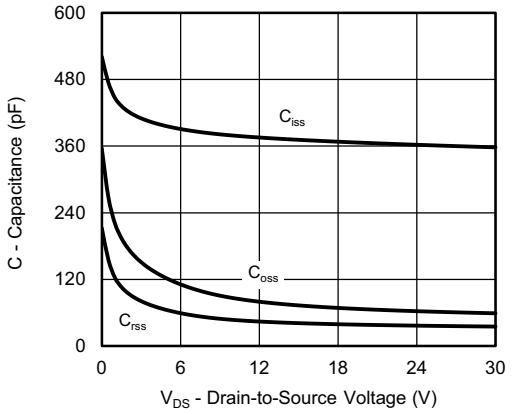



**Transconductance**

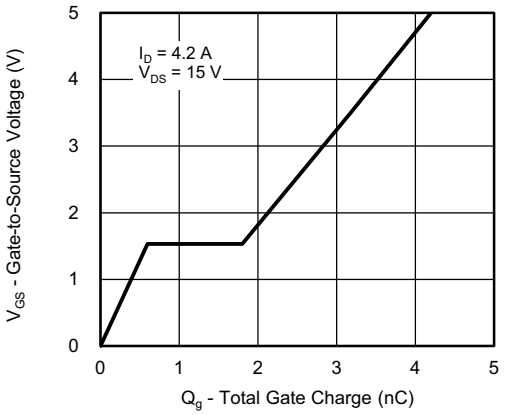



**On-Resistance vs. Drain Current**

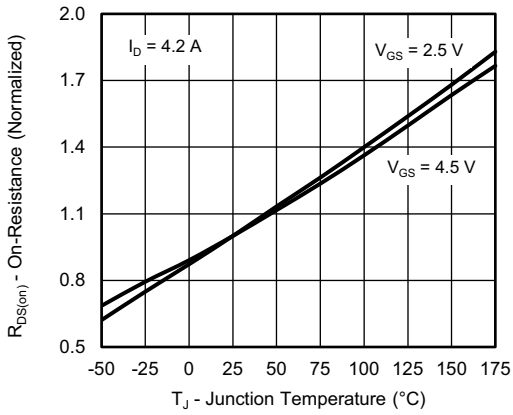
## TYPICAL CHARACTERISTICS ($T_A$ = 25 °C, unless otherwise noted)



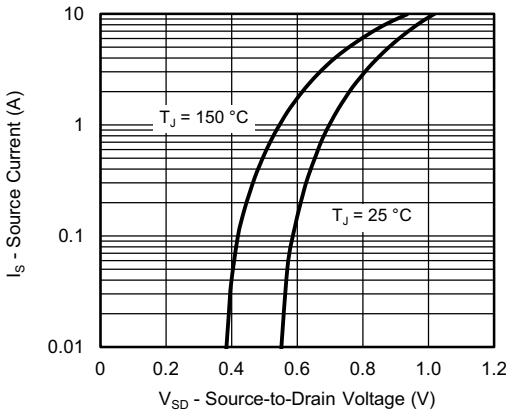

**Capacitance**



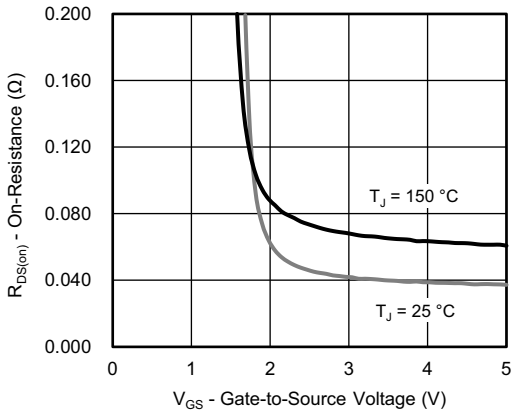

**Gate Charge**



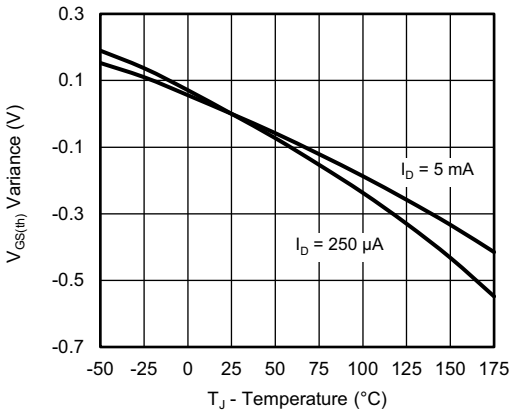

**On-Resistance vs. Junction Temperature**




**Source Drain Diode Forward Voltage**

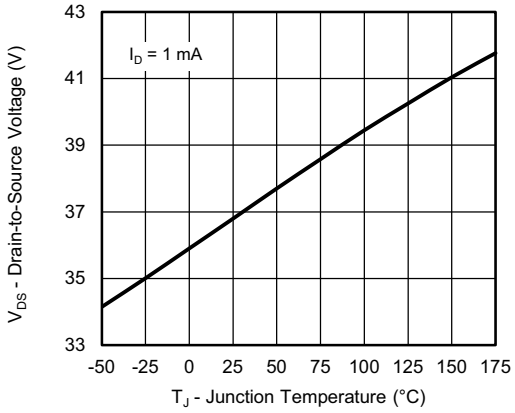



**On-Resistance vs. Gate-to-Source Voltage**

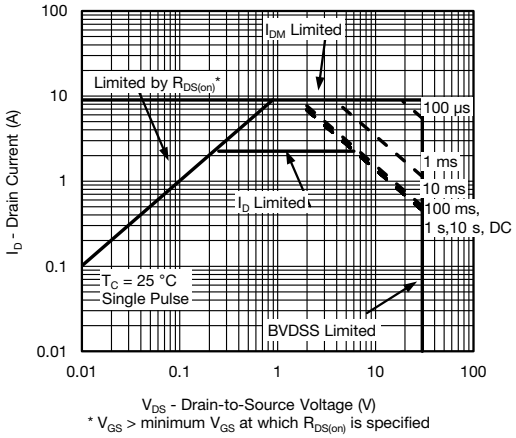



**Threshold Voltage**

## TYPICAL CHARACTERISTICS ($T_A$ = 25 °C, unless otherwise noted)

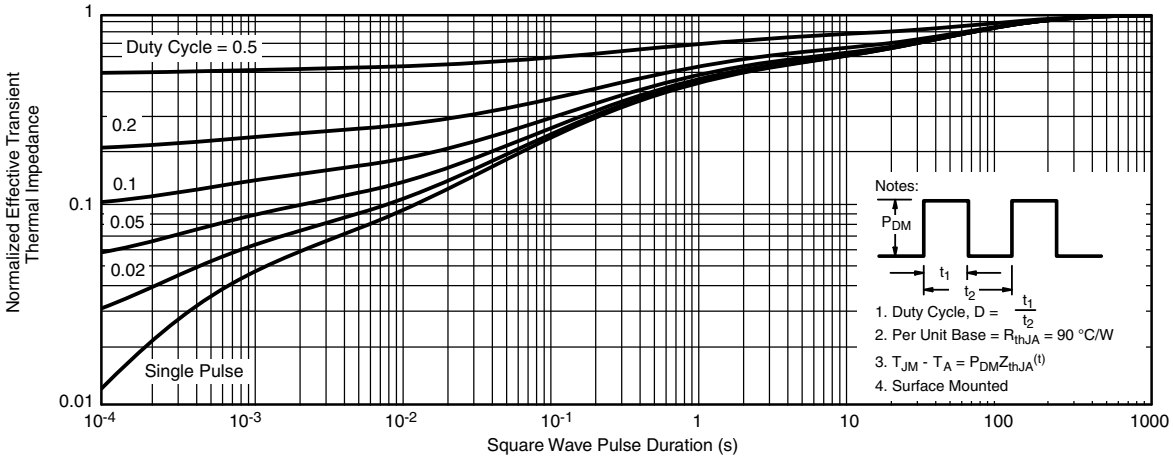



**Drain Source Breakdown vs. Junction Temperature**



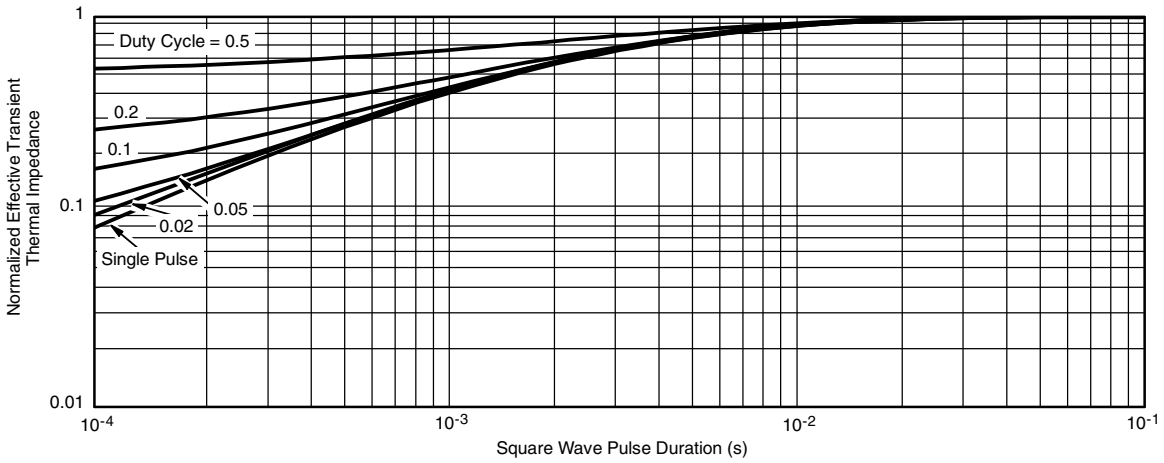

**Safe Operating Area**

## THERMAL RATINGS ($T_A$ = 25 °C, unless otherwise noted)




**Normalized Thermal Transient Impedance, Junction-to-Ambient**

**THERMAL RATINGS** ($T_A$ = 25 °C, unless otherwise noted)




**Normalized Thermal Transient Impedance, Junction-to-Case**

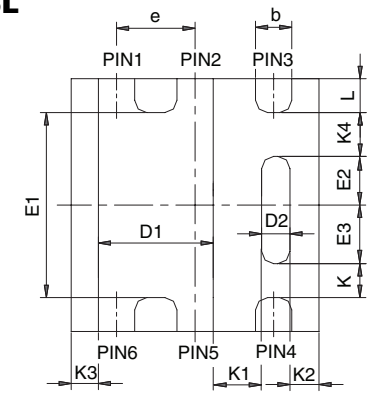
**Note**

- The characteristics shown in the two graphs
  - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
  - Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

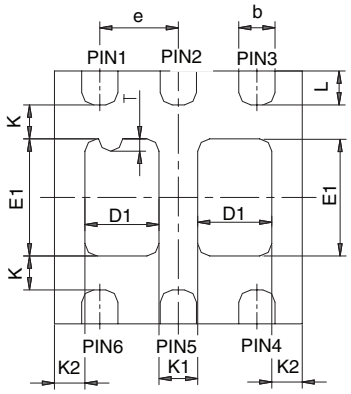
  are given for general guidelines only to enable the user to get a “ball park” indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

*Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?76236.*

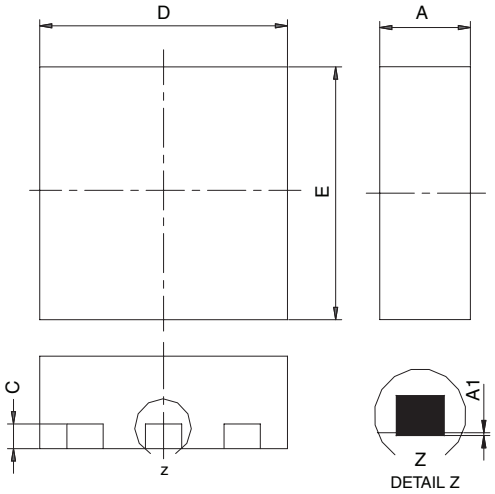
## PowerPAK® SC70-6L




BACKSIDE VIEW OF SINGLE




BACKSIDE VIEW OF DUAL



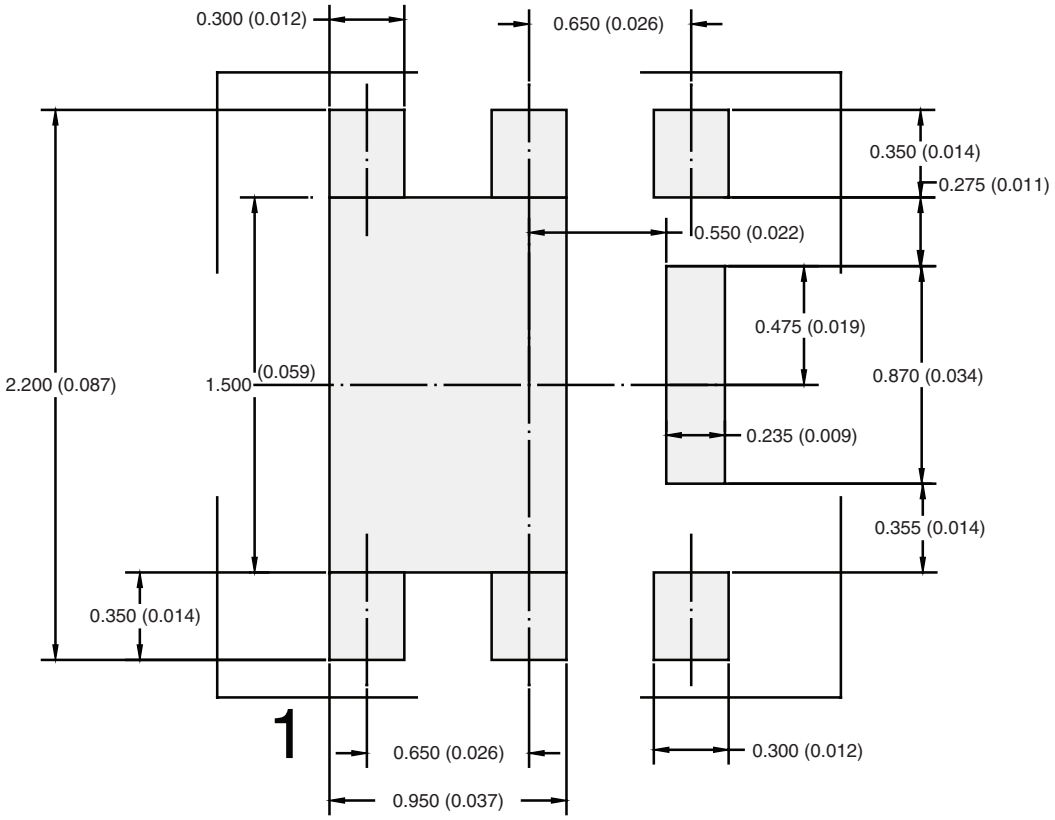

DETAIL Z

Notes:
1. All dimensions are in millimeters
2. Package outline exclusive of mold flash and metal burr
3. Package outline inclusive of plating

| DIM | SINGLE PAD | | | | | | DUAL PAD | | | | | |
|---|---|---|---|---|---|---|---|---|---|---|---|---|
| | MILLIMETERS | | | INCHES | | | MILLIMETERS | | | INCHES | | |
| | Min | Nom | Max | Min | Nom | Max | Min | Nom | Max | Min | Nom | Max |
| A | 0.675 | 0.75 | 0.80 | 0.027 | 0.030 | 0.032 | 0.675 | 0.75 | 0.80 | 0.027 | 0.030 | 0.032 |
| A1 | 0 | - | 0.05 | 0 | - | 0.002 | 0 | - | 0.05 | 0 | - | 0.002 |
| b | 0.23 | 0.30 | 0.38 | 0.009 | 0.012 | 0.015 | 0.23 | 0.30 | 0.38 | 0.009 | 0.012 | 0.015 |
| C | 0.15 | 0.20 | 0.25 | 0.006 | 0.008 | 0.010 | 0.15 | 0.20 | 0.25 | 0.006 | 0.008 | 0.010 |
| D | 1.98 | 2.05 | 2.15 | 0.078 | 0.081 | 0.085 | 1.98 | 2.05 | 2.15 | 0.078 | 0.081 | 0.085 |
| D1 | 0.85 | 0.95 | 1.05 | 0.033 | 0.037 | 0.041 | 0.513 | 0.613 | 0.713 | 0.020 | 0.024 | 0.028 |
| D2 | 0.135 | 0.235 | 0.335 | 0.005 | 0.009 | 0.013 | | | | | | |
| E | 1.98 | 2.05 | 2.15 | 0.078 | 0.081 | 0.085 | 1.98 | 2.05 | 2.15 | 0.078 | 0.081 | 0.085 |
| E1 | 1.40 | 1.50 | 1.60 | 0.055 | 0.059 | 0.063 | 0.85 | 0.95 | 1.05 | 0.033 | 0.037 | 0.041 |
| E2 | 0.345 | 0.395 | 0.445 | 0.014 | 0.016 | 0.018 | | | | | | |
| E3 | 0.425 | 0.475 | 0.525 | 0.017 | 0.019 | 0.021 | | | | | | |
| e | 0.65 BSC | | | 0.026 BSC | | | 0.65 BSC | | | 0.026 BSC | | |
| K | 0.275 TYP | | | 0.011 TYP | | | 0.275 TYP | | | 0.011 TYP | | |
| K1 | 0.400 TYP | | | 0.016 TYP | | | 0.320 TYP | | | 0.013 TYP | | |
| K2 | 0.240 TYP | | | 0.009 TYP | | | 0.252 TYP | | | 0.010 TYP | | |
| K3 | 0.225 TYP | | | 0.009 TYP | | | | | | | | |
| K4 | 0.355 TYP | | | 0.014 TYP | | | | | | | | |
| L | 0.175 | 0.275 | 0.375 | 0.007 | 0.011 | 0.015 | 0.175 | 0.275 | 0.375 | 0.007 | 0.011 | 0.015 |
| T | | | | | | | 0.05 | 0.10 | 0.15 | 0.002 | 0.004 | 0.006 |

ECN: C-07431 – Rev. C, 06-Aug-07
DWG: 5934

**RECOMMENDED PAD LAYOUT FOR PowerPAK® SC70-6L Single**




Dimensions in mm/(Inches)

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